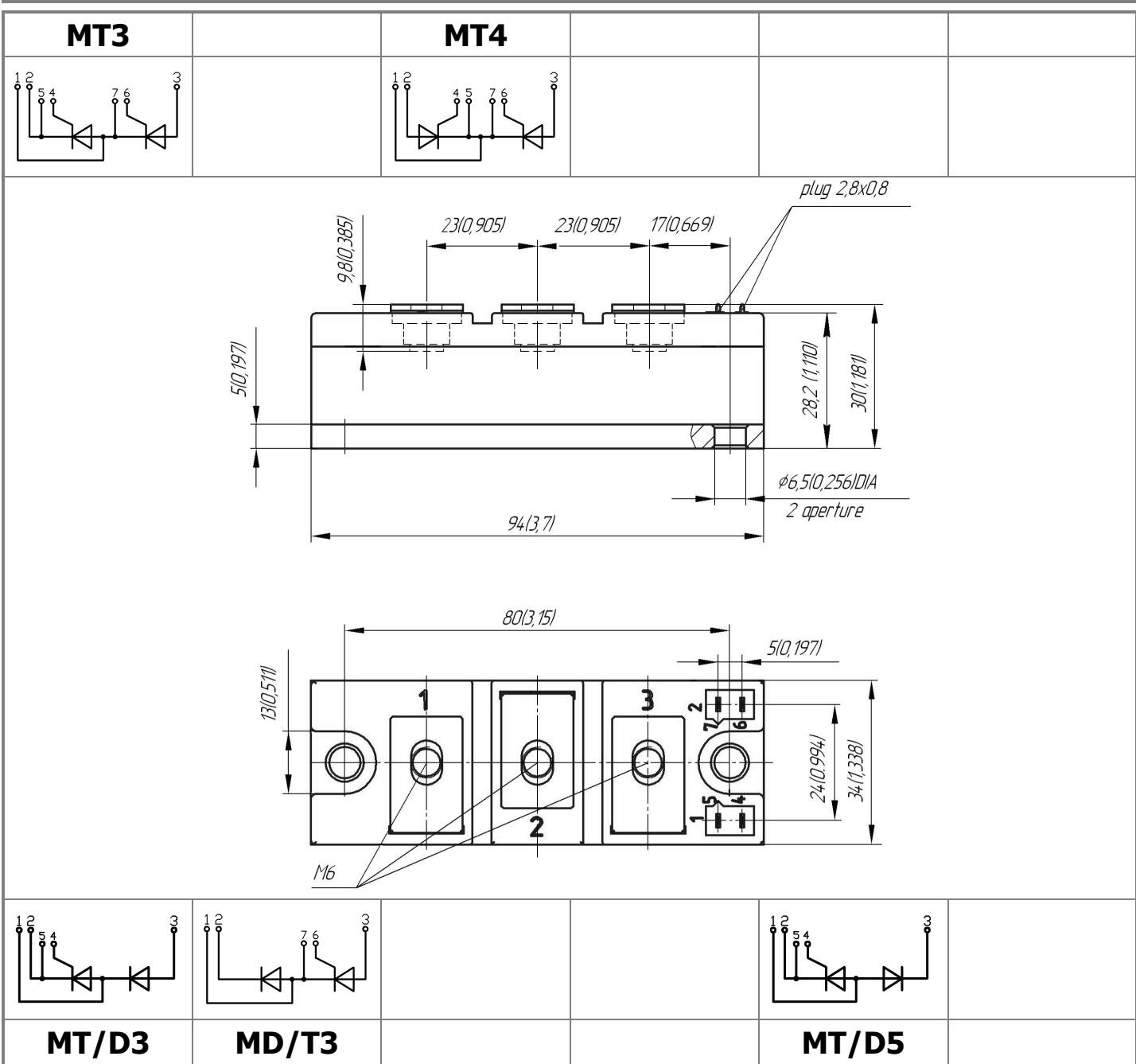


Electrically isolated base plate  
 Industrial standard package  
 Simplified mechanical design, rapid assembly  
 Pressure contact

## Double Thyristor Module For Phase Control **MTx-165-22-F**

Mean on-state current	I <sub>TAV</sub>	165 A
Repetitive peak off-state voltage	V <sub>DRM</sub>	
Repetitive peak reverse voltage	V <sub>RRM</sub>	2000 ÷ 2200 V
Turn-off time	t <sub>q</sub>	125 µs
V <sub>DRM</sub> , V <sub>RRM</sub> , V	2000	2200
Voltage code	20	22
T <sub>j</sub> , °C	- 40 ÷ 125	



## MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	165	$T_c = 85^\circ C$ ; 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	259		
$I_{TSM}$	Surge on-state current	kA	4.7 5.5	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; 50 Hz ( $t_p = 10$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$
			5.0 5.8	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; 60 Hz ( $t_p = 8.3$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$
$I^2t$	Safety factor	$A^2 s \cdot 10^3$	110 145	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; 50 Hz ( $t_p = 10$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$
			100 135	$T_j = T_{j \max}$ $T_j = 25^\circ C$	180° half-sine wave; 60 Hz ( $t_p = 8.3$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000÷2200	$T_{j \min} < T_j < T_{j \max}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100÷2300	$T_{j \min} < T_j < T_{j \max}$ ; 180° half-sine wave; 50 Hz; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.75 \cdot V_{DRM}$ $0.75 \cdot V_{RRM}$	$T_j = T_{j \max}$ ; Gate open	
<b>TRIGGERING</b>					
$I_{FGM}$	Peak forward gate current	A	5	$T_j = T_{j \max}$	
$V_{RGM}$	Peak reverse gate voltage	V	5		
$P_G$	Gate power dissipation	W	3	$T_j = T_{j \max}$ for DC gate current	
<b>SWITCHING</b>					
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu s$	500	$T_j = T_{j \max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 2 I_{TAV}$ ; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$	
<b>THERMAL</b>					
$T_{stg}$	Storage temperature	°C	-40 ÷ 125		
$T_j$	Operating junction temperature	°C	-40 ÷ 125		
<b>MECHANICAL</b>					
a	Acceleration under vibration	$m/s^2$	50		

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
<b>ON-STATE</b>				
$V_{TM}$	Peak on-state voltage, max	V	1.50	$T_j=25\text{ }^{\circ}\text{C}; I_{TM}=500\text{ A}$
$V_{T(TO)}$	On-state threshold voltage, max	V	0.80	$T_j=T_{j\max}$ ;
$r_T$	On-state slope resistance, max	$\text{m}\Omega$	1.350	$0.5\pi I_{TAV} < I_T < 1.5\pi I_{TAV}$
$I_L$	Latching current, max	mA	500	$T_j=25\text{ }^{\circ}\text{C}; V_D=12\text{ V};$ Gate pulse: $I_G=2\text{ A}$ ; $t_{GP}=50\text{ }\mu\text{s}; \frac{di_G}{dt}\geq 1\text{ A}/\mu\text{s}$
$I_H$	Holding current, max	mA	250	$T_j=25\text{ }^{\circ}\text{C};$ $V_D=12\text{ V};$ Gate open
<b>BLOCKING</b>				
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	30	$T_j=T_{j\max}$ ; $V_D=V_{DRM}; V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage, min	$\text{V}/\mu\text{s}$	1000	$T_j=T_{j\max}$ ; $V_D=0.67V_{DRM};$ Gate open
<b>TRIGGERING</b>				
$V_{GT}$	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j=T_{j\min}$ $T_j=25\text{ }^{\circ}\text{C}$ $T_j=T_{j\max}$
$I_{GT}$	Gate trigger direct current, max	mA	400 250 200	$T_j=T_{j\min}$ $T_j=25\text{ }^{\circ}\text{C}$ $T_j=T_{j\max}$
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.25	$T_j=T_{j\max}$ ; $V_D=0.67V_{DRM};$
$I_{GD}$	Gate non-trigger direct current, min	mA	10.00	Direct gate current
<b>SWITCHING</b>				
$t_{gd}$	Delay time	$\mu\text{s}$	2.50	$T_j=25\text{ }^{\circ}\text{C}; V_D=0.4V_{DRM}; I_{TM}=I_{TAV};$ Gate pulse: $I_G=2\text{ A}$ ; $t_{GP}=50\text{ }\mu\text{s}; \frac{di_G}{dt}\geq 1\text{ A}/\mu\text{s}$
$t_q$	Turn-off time, max	$\mu\text{s}$	125	$dv_D/dt=50\text{ V}/\mu\text{s}; T_j=T_{j\max}; I_{TM}=200\text{ A};$ $di_R/dt=-10\text{ A}/\mu\text{s}; V_R=100\text{ V};$ $V_D=0.67V_{DRM};$
$Q_{rr}$	Total recovered charge, max	$\mu\text{C}$	855	$T_j=T_{j\max}; I_{TM}=200\text{ A};$
$t_{rr}$	Reverse recovery time, max	$\mu\text{s}$	18	$di_R/dt=-10\text{ A}/\mu\text{s};$
$I_{rrM}$	Peak reverse recovery current, max	A	95	$V_R=100\text{ V}$
<b>THERMAL</b>				
$R_{thjc}$	Thermal resistance, junction to case			
	per module	$^{\circ}\text{C}/\text{W}$	0.0900	$180^{\circ}$ half-sine wave, 50 Hz
	per arm	$^{\circ}\text{C}/\text{W}$	0.1800	
	per module	$^{\circ}\text{C}/\text{W}$	0.0850	DC
	per arm	$^{\circ}\text{C}/\text{W}$	0.1700	
$R_{thch}$	Thermal resistance, case to heatsink			
	per module	$^{\circ}\text{C}/\text{W}$	0.0300	
	per arm	$^{\circ}\text{C}/\text{W}$	0.0600	
<b>INSULATION</b>				
$V_{ISOL}$	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; $t=1\text{ min}$
			3.60	$t=1\text{ sec}$
<b>MECHANICAL</b>				
$M_1$	Mounting torque (M6) <sup>1)</sup>	Nm	6.00	Tolerance $\pm 15\%$
$M_2$	Terminal connection torque (M6) <sup>1)</sup>	Nm	6.00	Tolerance $\pm 15\%$
w	Weight	g	320	

PART NUMBERING GUIDE	NOTES																				
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="padding: 2px;">MT</td> <td style="padding: 2px;">3</td> <td style="padding: 2px;">-</td> <td style="padding: 2px;">165</td> <td style="padding: 2px;">-</td> <td style="padding: 2px;">22</td> <td style="padding: 2px;">-</td> <td style="padding: 2px;">F</td> <td style="padding: 2px;">-</td> <td style="padding: 2px;">N</td> </tr> <tr> <td style="text-align: center; padding: 2px;">1</td> <td style="text-align: center; padding: 2px;">2</td> <td></td> <td style="text-align: center; padding: 2px;">3</td> <td></td> <td style="text-align: center; padding: 2px;">4</td> <td></td> <td style="text-align: center; padding: 2px;">5</td> <td></td> <td style="text-align: center; padding: 2px;">6</td> </tr> </table> <p>           1. Thyristor module (MT)            Thyristor – Diode module (MT/D)            Diode – Thyristor module (MD/T)            2. Circuit Schematic            3. Average On-state Current, A            4. Voltage Code            5. Package Type (M.F)            6. Ambient Conditions:            N – Normal         </p>	MT	3	-	165	-	22	-	F	-	N	1	2		3		4		5		6	<p><sup>1)</sup> The screws must be lubricated</p>
MT	3	-	165	-	22	-	F	-	N												
1	2		3		4		5		6												